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Data Sheet November 2013

8 A, 400 V - 600 V, Ultrafast Diodes

Description

The MUR840, MUR860, RURP840, RURP860 is an ultrafast diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

Ordering Information

| PART NUMBER | PACKAGE | BRAND |
|-------------|-------------|---------|
| MUR840 | TO-220AC-2L | MUR840 |
| RURP840 | TO-220AC-2L | RURP840 |
| MUR860 | TO-220AC-2L | MUR860 |
| RURP860 | TO-220AC-2L | RURP860 |

NOTE: When ordering, use the entire part number.

Symbol



Features

- Ultrafast Recovery $t_{rr} = 70 \text{ ns } (@ I_F = 8 \text{ A})$
- Max Forward Voltage, V_F = 1.5 V (@ T_C = 25°C)
- 400 V, 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS Compliant

Applications

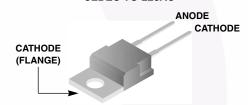
- Switching Power Supplies
- Power Switching Circuits

MIIDOAO

General Purpose

Packaging

JEDEC TO-220AC



MIIDOGO

| Absolute Maximum Ra | tings $T_C = 25$ | 5°C, Unless Otherwise Specified |
|---------------------|------------------|---------------------------------|
| | | |

| | MUR840 RURP840 | MUR860 RURP860 | UNIT |
|--|-------------------|-------------------|------|
| Peak Repetitive Reverse VoltageV _{RRM} | 400 | 600 | V |
| Working Peak Reverse Voltage | 400 | 600 | V |
| DC Blocking VoltageV _R | 400 | 600 | V |
| Average Rectified Forward Current $I_{F(AV)}$ ($T_C = 155^{\circ}C$) | 8 | 8 | Α |
| Repetitive Peak Surge Current I _{FRM} (Square Wave, 20kHz) | 16 | 16 | Α |
| Nonrepetitive Peak Surge Current | 100 | 100 | Α |
| Maximum Power Dissipation | 75 | 75 | W |
| Avalanche Energy (See Figures 10 and 11) | 20 | 20 | mJ |
| Operating and Storage Temperature | -65 to 175 | -65 to 175 | oC |
| Maximum Lead Temperature for Soldering | | | |
| Leads at 0.063 in. (1.6mm) from case for 10s $\dots \ T_L$ | 300 | 300 | oC |
| Package Body for 10s, see Tech Brief 334 | 260 | 260 | oC |

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Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

| | | MUR840, RURP840 | | MUR860, RURP860 | | | | |
|-----------------|---|-----------------|-----|-----------------|-----|-----|-----|------|
| SYMBOL | TEST CONDITION | MIN | ТҮР | MAX | MIN | TYP | МАХ | UNIT |
| V _F | I _F = 8 A | - | - | 1.3 | - | - | 1.5 | V |
| | I _F = 8 A, T _C = 150 ^o C | - | - | 1.0 | - | - | 1.2 | V |
| I _R | V _R = 400 V | - | - | 100 | - | - | - | μА |
| | V _R = 600 V | - | - | - | - | - | 100 | μА |
| | V _R = 400 V, T _C = 150 ^o C | - | - | 500 | - | - | - | μА |
| | $V_R = 600 \text{ V}, T_C = 150^{\circ}\text{C}$ | - | - | - | - | - | 500 | μА |
| t _{rr} | I _F = 1 A, dI _F /dt = 200 A/μs | - | - | 60 | - | - | 60 | ns |
| | I _F = 8 A, dI _F /dt = 200 A/μs | - | - | 70 | - | - | 70 | ns |
| t _a | I _F = 8 A, dI _F /dt = 200 A/μs | - | 32 | - | - | 32 | - | ns |
| t _b | I _F = 8 A, dI _F /dt = 200 A/μs | - | 21 | - | - | 21 | - | ns |
| Q _{rr} | I _F = 8 A, dI _F /dt = 200 A/μs | - | 195 | - | - | 195 | - | nC |
| СЈ | V _R = 10 V, I _F = 0 A | - | 25 | - | - | 25 | - | pF |
| $R_{\theta JC}$ | | - | - | 2 | - | - | 2 | °C/W |

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 T_{rr} = Reverse recovery time (See Figure 9), summation of $t_a + t_b$.

ta = Time to reach peak reverse current (See Figure 9).

 t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 9).

Q_{rr} = Reverse recovery charge.

C_J = Junction Capacitance.

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

Typical Performance Curves

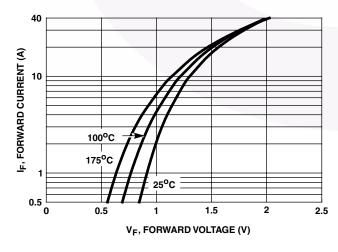


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

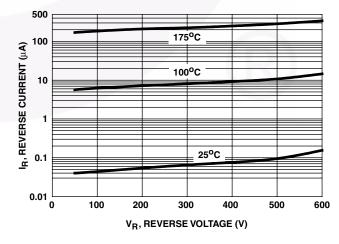


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

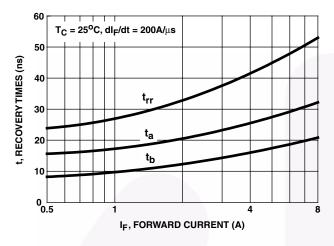


FIGURE 3. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

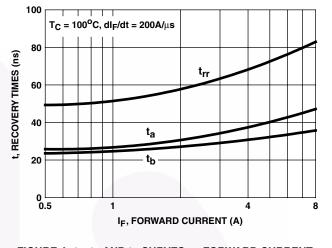


FIGURE 4. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

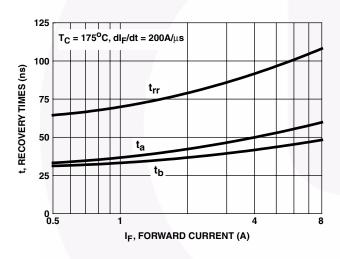


FIGURE 5. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

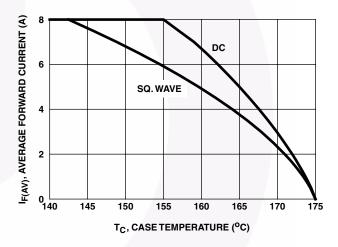


FIGURE 6. CURRENT DERATING CURVE

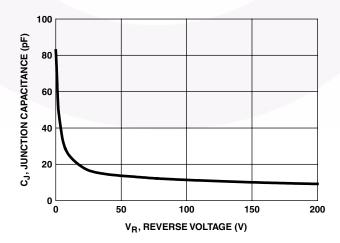


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuits and Waveforms

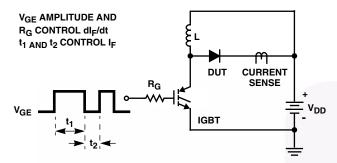


FIGURE 8. t_{rr} TEST CIRCUIT

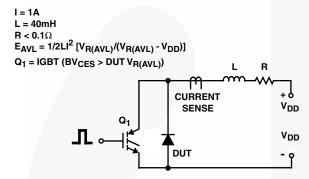


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

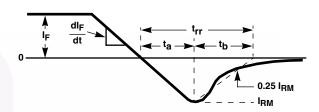


FIGURE 9. t_{rr} WAVEFORMS AND DEFINITIONS

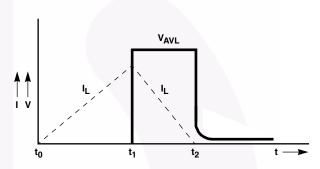


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Mechanical Dimensions

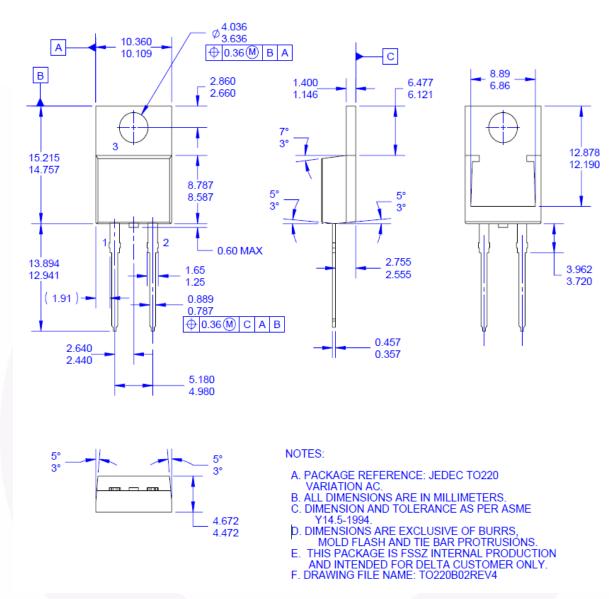


Figure 12. TO-220 2L - TO-220, MOLDED, 2LD

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